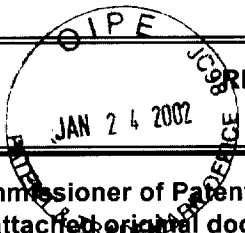


01-31-2002



101978831

Docket : 33036W045



RECORDATION COVER SHEET
PATENTS

To the Honorable Commissioner of Patents and Trademarks:
Please record the attached original documents or copies thereof.

1. Name(s) of conveying party(ies):

Tung Teck Hong and Hideto Aoki

2. Name(s) and Address(es) of receiving party(ies):

SUMITOMO BAKELITE CO., LTD.
5-8, Higashishinagawa 2-chome
Shinagawa-ku
Tokyo, JAPAN

Sumicarrier Singapore Pte., Ltd.
72 Senoko Drive
Singapore 758240

3. Nature of conveyance: Assignment
Execution Date: January 10, 2002

4A. Application Serial No. 10/007,623
Application Filed: December 5, 2001

5. Name and Address of Party to whom correspondence regarding this document should be mailed:
Smith, Gambrell & Russell, LLP
1850 M Street N.W. (Suite 800)
Washington, DC 20036
202 659-2811

6. Total number of applications and patents involved : one

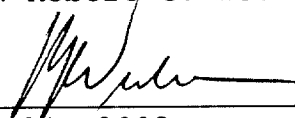
7. Total fee: \$40.00.
(Enclosed. Please charge any deficiency or refund any excess to counsel's deposit account.)

8. Deposit account no.: 02-4300

DO NOT USE THIS SPACE

9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct, and any attached copy is a true copy of the original document.

Name of Person Signing : Robert G. Weilacher, Reg. No. 20,531

Signature: 
Date: January 24, 2002

1.24.02

EC 22-017

ASSIGNMENT

(讓渡証)

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to Tung Teck Hong, and Hideto AOKI, citizens of Singapore and Japan by SUMITOMO BAKELITE COMPANY LIMITED, a corporation organized under the laws of Japan, located at 5-8, Higashishinagawa 2-chome, Shinagawa-ku, Tokyo, Japan and SUMICARRIER SINGAPORE PTE., LTD., a corporation organized under the laws of Singapore, located at 72, Senoko Drive Singapore 758240, respectively,

receipt of which is hereby acknowledged, we, the said Tung Teck Hong, and Hideto AOKI, do hereby sell and assign to said SUMITOMO BAKELITE COMPANY LIMITED, and SUMICARRIER SINGAPORE PTE., LTD.,

their successors and assigns, all our right, title and interest, in and for the United States of America, in and to "METHOD AND MOLD FOR PRODUCING THERMOPLASTIC RESIN CONTAINER"

* U.S. Serial No. 10/007,623 filed on December 5, 2001

invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said SUMITOMO BAKELITE COMPANY LIMITED, and SUMICARRIER SINGAPORE PTE., LTD.,

their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said SUMITOMO BAKELITE COMPANY LIMITED, and SUMICARRIER SINGAPORE PTE., LTD.

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)	WITNESSES (立会人サイン)
1) <u>Tung Teck Hong</u> Tung Teck Hong	<u>January 10, 2002</u>	<u>Toshiyuki Seki</u>
2) <u>Hideto Aoki</u> Hideto AOKI	<u>January 10, 2002</u>	<u>Toshiyuki Seki</u>
3) _____	_____	_____
4) _____	_____	_____
5) _____	_____	_____
6) _____	_____	_____
7) _____	_____	_____
8) _____	_____	_____
9) _____	_____	_____